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United States Patent [19]
Morita

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[54] **BASE BOARD FOR A PACKAGE**

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[**] Term: **14 Years**

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[22] Filed: **Jul. 25, 1994**
[52] **U.S. Cl.** **D9/415**
[58] **Field of Search** D9/415, 418, 433,
D9/457; 206/461-471, 806, 495

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Primary Examiner—Prabhakar G. Deshmukh
Attorney, Agent, or Firm—Cushman Darby & Cushman

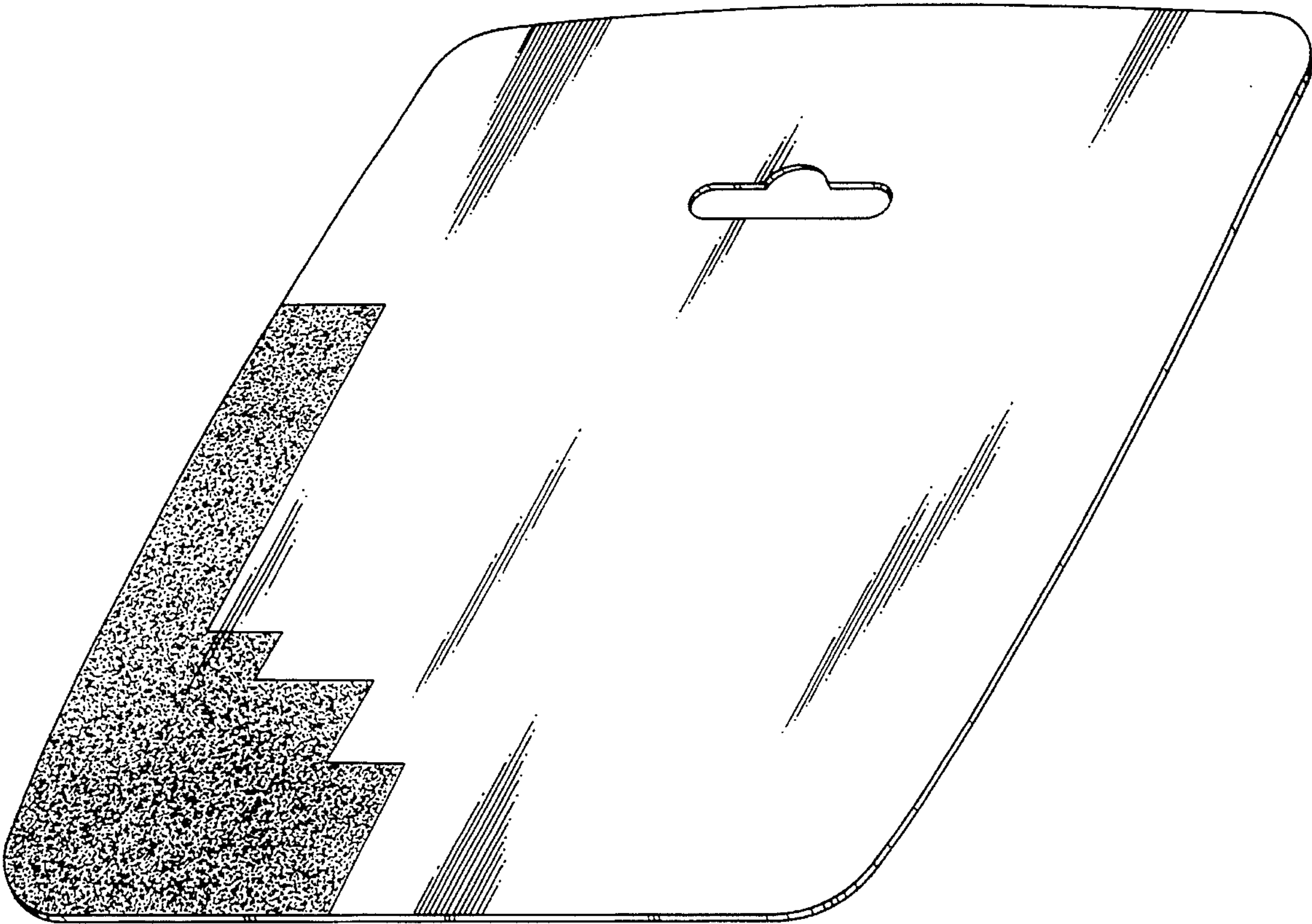
[57] **CLAIM**

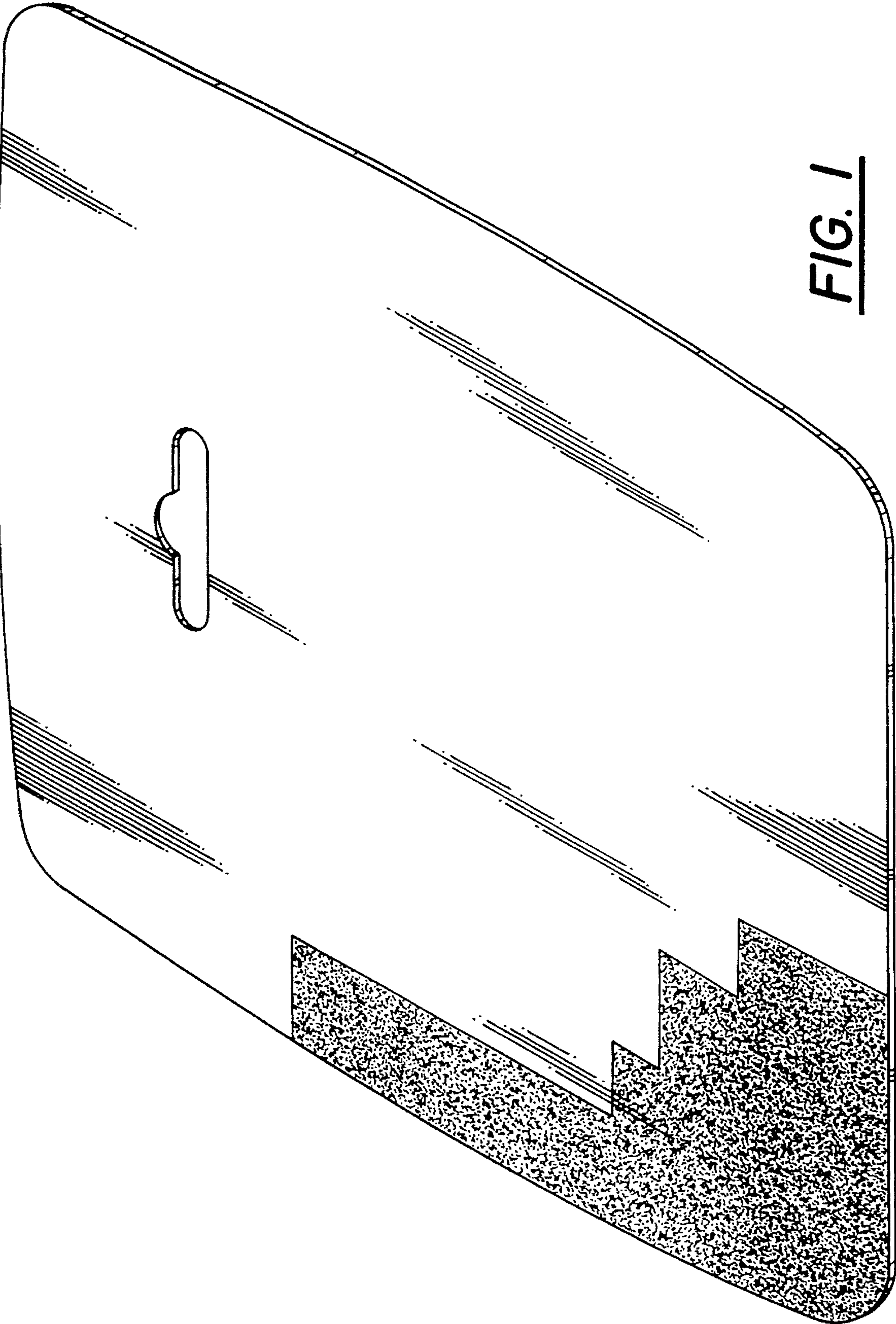
The ornamental design for a base board for a package, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a base board for a package from the front, right side and bottom;
FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a right side elevational view thereof, the left side being identical thereto; and,
FIG. 5 is a top plan view thereof, the bottom being identical thereto.
The stippling which appears in FIGS. 1 and 2 depicts a graphical pattern on the front surface of the article.

1 Claim, 4 Drawing Sheets





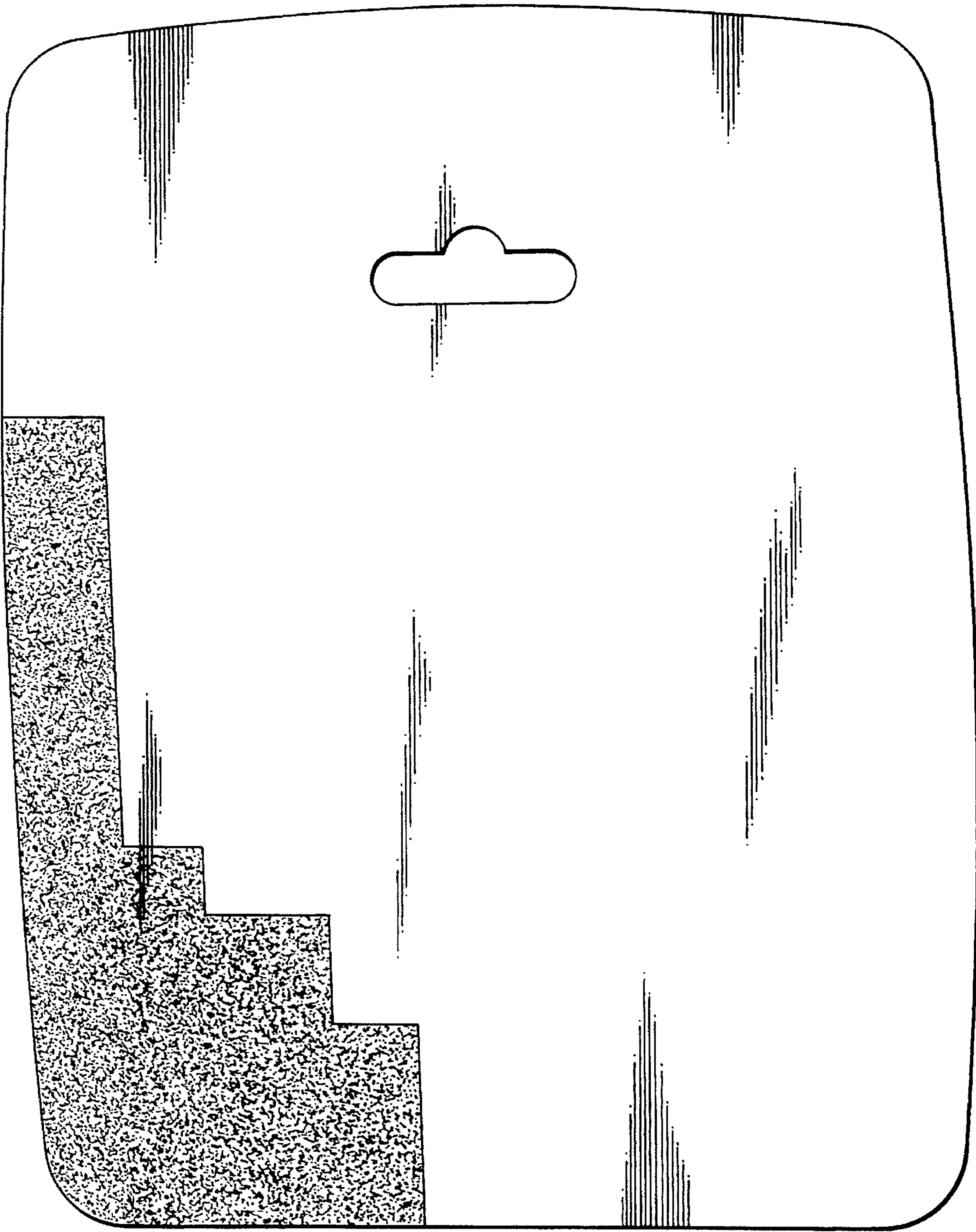


FIG. 2

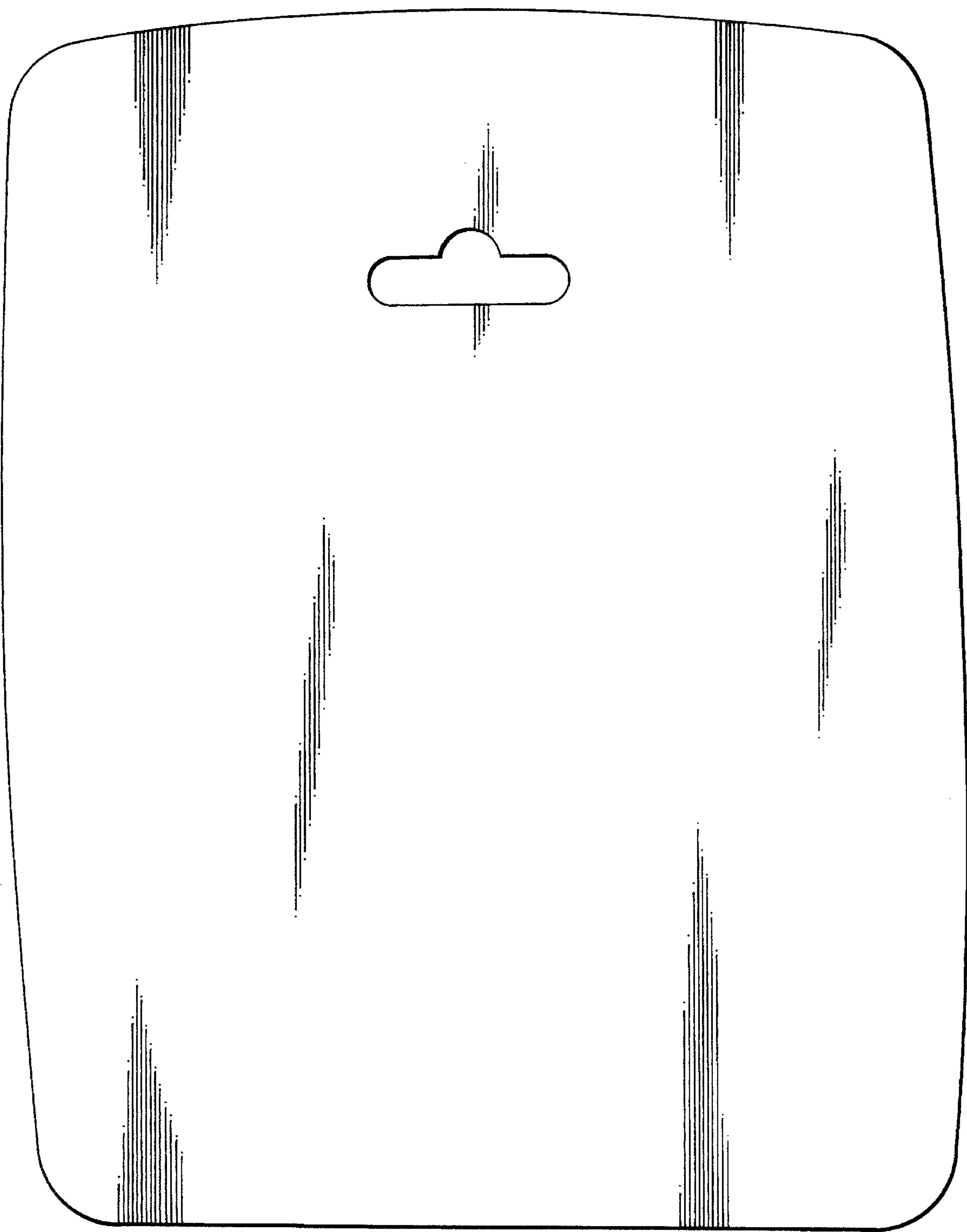


FIG. 3



FIG. 4



FIG. 5